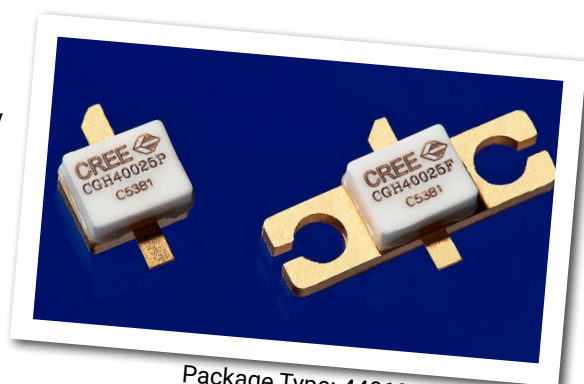


CGH40025

25 W, RF Power GaN HEMT

Cree's CGH40025 is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT). The CGH40025, operating from a 28 volt rail, offers a general purpose, broadband solution to a variety of RF and microwave applications. GaN HEMTs offer high efficiency, high gain and wide bandwidth capabilities making the CGH40025 ideal for linear and compressed amplifier circuits. The transistor is available in a screw-down, flange package and solder-down, pill packages.



Package Type: 440196 and 440166
PN: CGH40025P and CGH40025F

FEATURES

- Up to 6 GHz Operation
- 15 dB Small Signal Gain at 2.0 GHz
- 13 dB Small Signal Gain at 4.0 GHz
- 30 W typical P_{SAT}
- 62 % Efficiency at P_{SAT}
- 28 V Operation

APPLICATIONS

- 2-Way Private Radio
- Broadband Amplifiers
- Cellular Infrastructure
- Test Instrumentation
- Class A, AB, Linear amplifiers suitable for OFDM, W-CDMA, EDGE, CDMA waveforms



Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V_{DS}	84	Volts	25°C
Gate-to-Source Voltage	V_{GS}	-10, +2	Volts	25°C
Storage Temperature	T_{STG}	-65, +150	°C	
Operating Junction Temperature	T_J	225	°C	
Maximum Forward Gate Current	I_{GMAX}	7.0	mA	25°C
Maximum Drain Current ¹	I_{DMAX}	3	A	25°C
Soldering Temperature ²	T_S	245	°C	
Screw Torque	τ	60	in-oz	
Thermal Resistance, Junction to Case ³	R_{JC}	4.8	°C/W	85°C
Case Operating Temperature ^{3,4}	T_C	-40, +150	°C	

Note:

¹ Current limit for long term, reliable operation

² Refer to the Application Note on soldering at www.cree.com/RF/Document-Library

³ Measured for the CGH40025F at $P_{DISS} = 28$ W.

⁴ See also, the Power Dissipation De-rating Curve on Page 6.

Electrical Characteristics ($T_C = 25^\circ\text{C}$)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics¹						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V_{DC}	$V_{DS} = 10$ V, $I_D = 7.2$ mA
Gate Quiescent Voltage	$V_{GS(Q)}$	—	-2.7	—	V_{DC}	$V_{DS} = 28$ V, $I_D = 250$ mA
Saturated Drain Current	I_{DS}	5.8	7.0	—	A	$V_{DS} = 6.0$ V, $V_{GS} = 2.0$ V
Drain-Source Breakdown Voltage	V_{BR}	120	—	—	V_{DC}	$V_{GS} = -8$ V, $I_D = 7.2$ mA
RF Characteristics² ($T_C = 25^\circ\text{C}$, $F_0 = 3.7$ GHz unless otherwise noted)						
Small Signal Gain	G_{SS}	12	13	—	dB	$V_{DD} = 28$ V, $I_{DQ} = 250$ mA
Power Output ³	P_{SAT}	20	30	—	W	$V_{DD} = 28$ V, $I_{DQ} = 250$ mA
Drain Efficiency ⁴	η	55	62	—	%	$V_{DD} = 28$ V, $I_{DQ} = 250$ mA, P_{SAT}
Output Mismatch Stress	VSWR	—	—	10 : 1	Ψ	No damage at all phase angles, $V_{DD} = 28$ V, $I_{DQ} = 250$ mA, $P_{OUT} = 25$ W CW
Dynamic Characteristics						
Input Capacitance	C_{GS}	—	9.0	—	pF	$V_{DS} = 28$ V, $V_{GS} = -8$ V, $f = 1$ MHz
Output Capacitance	C_{DS}	—	2.6	—	pF	$V_{DS} = 28$ V, $V_{GS} = -8$ V, $f = 1$ MHz
Feedback Capacitance	C_{GD}	—	0.4	—	pF	$V_{DS} = 28$ V, $V_{GS} = -8$ V, $f = 1$ MHz

Notes:

¹ Measured on wafer prior to packaging.

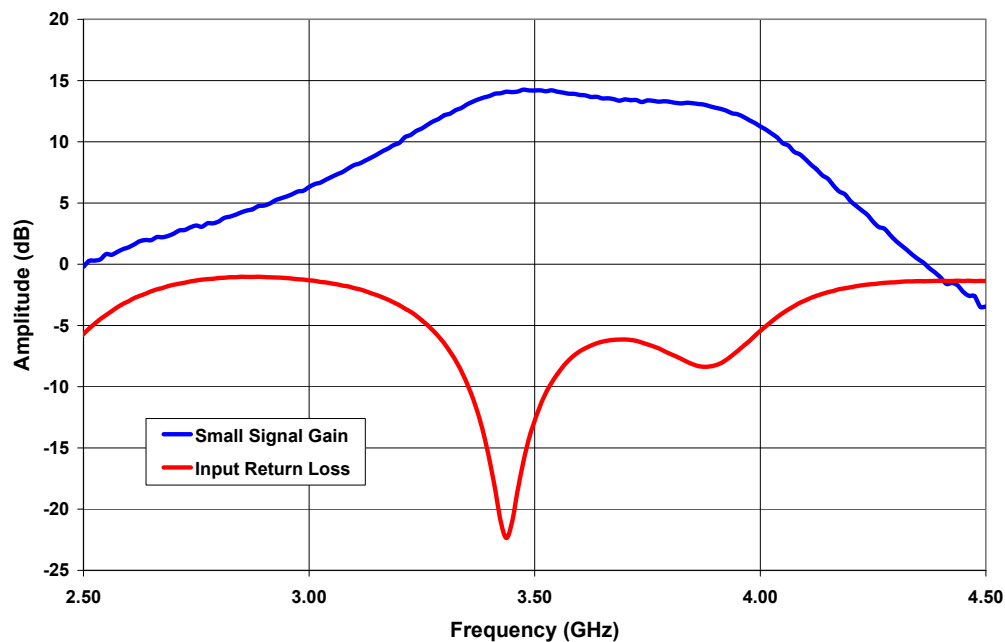
² Measured in CGH40025-AMP.

³ P_{SAT} is defined as $I_G = 0.72$ mA.

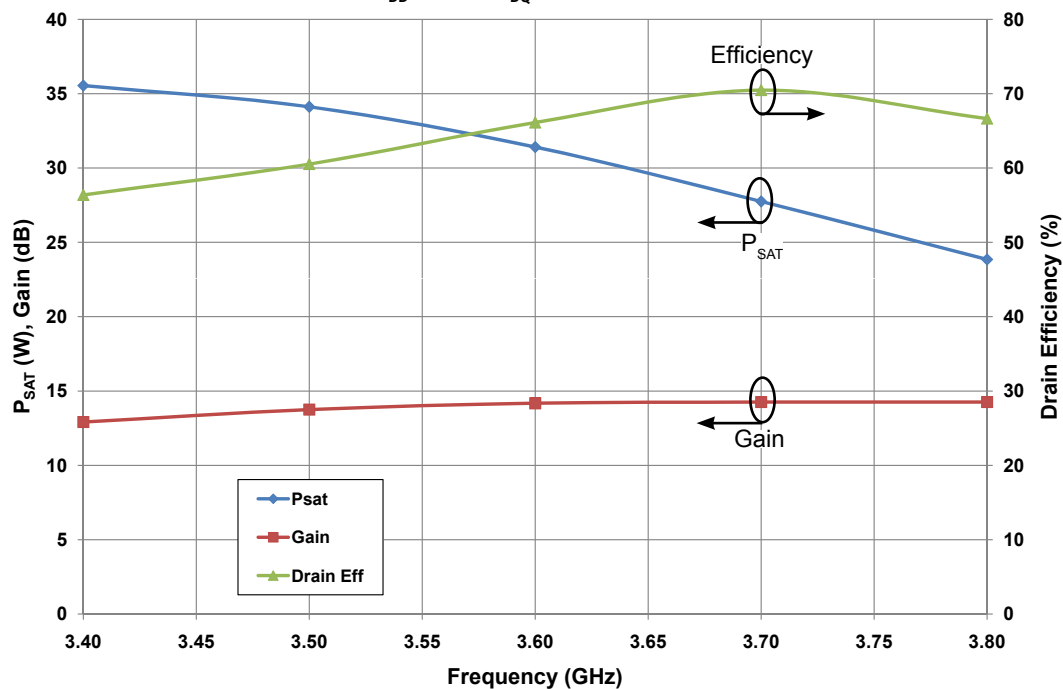
⁴ Drain Efficiency = P_{OUT} / P_{DC}

Typical Performance

Small Signal Gain and Return Loss vs Frequency of the CGH40025F in the CGH40025-AMP

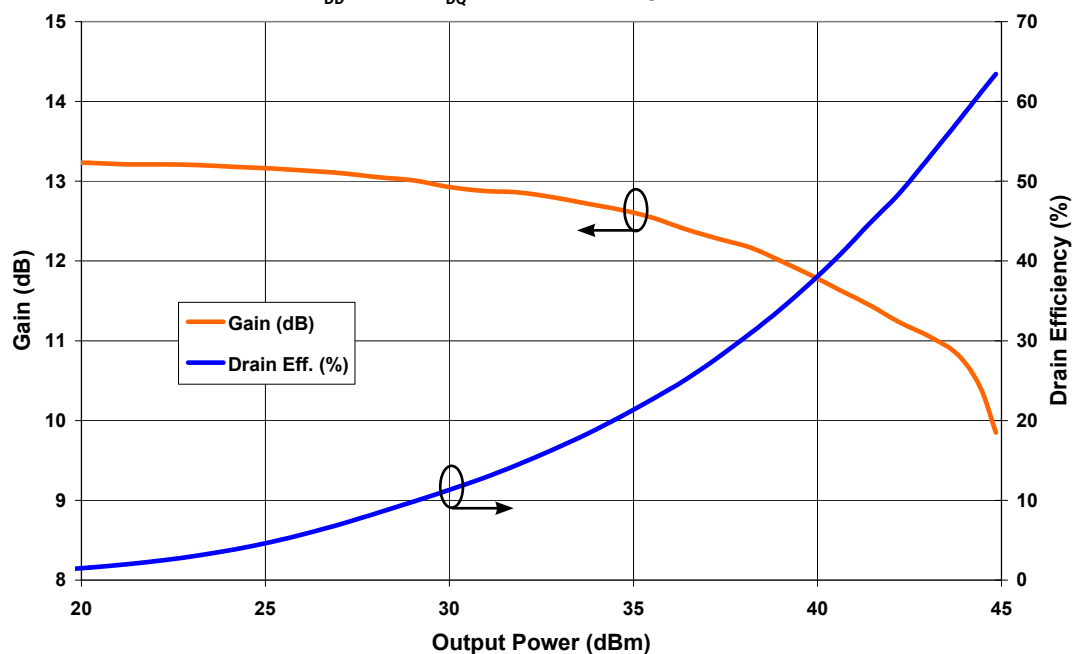


P_{SAT} Gain, and Drain Efficiency vs Frequency of the CGH40025F in the CGH40025-AMP
 $V_{DD} = 28\text{ V}$, $I_{DQ} = 250\text{ mA}$

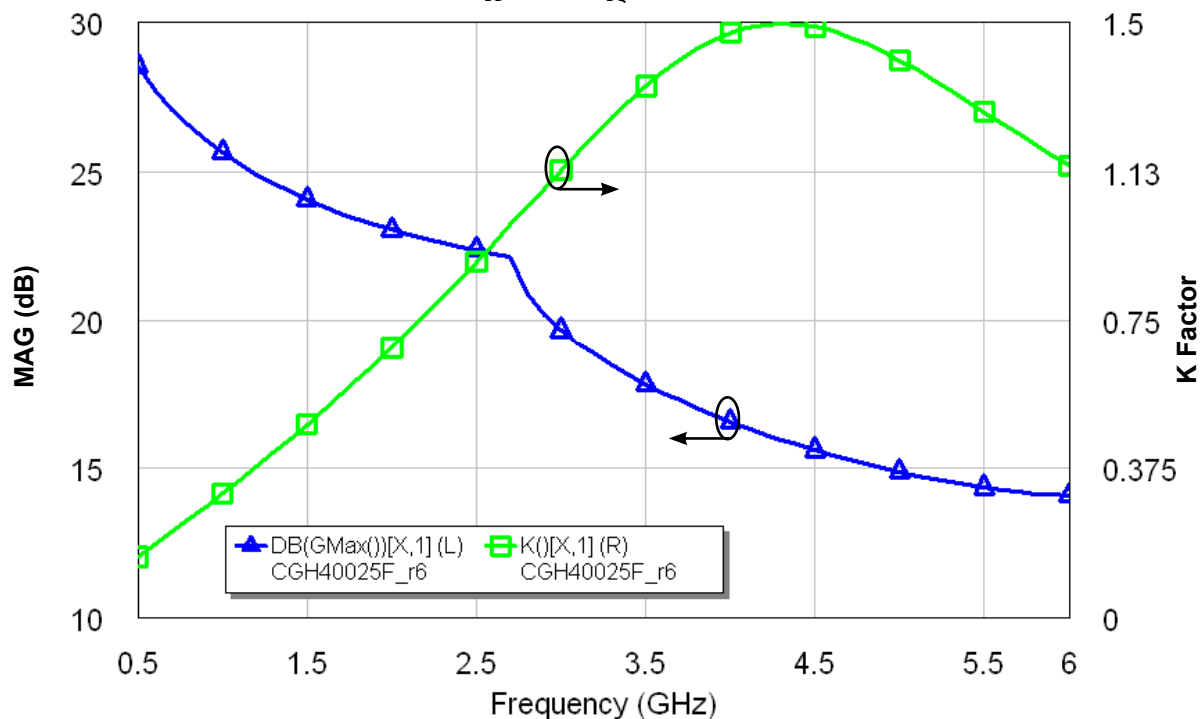


Typical Performance

**Swept CW Data of CGH40025 vs. Output Power with Source
 and Load Impedances Optimized for P_{SAT} Power in CGH40025-AMP**
 $V_{DD} = 28\text{ V}$, $I_{DQ} = 250\text{ mA}$, Freq = 3.7 GHz

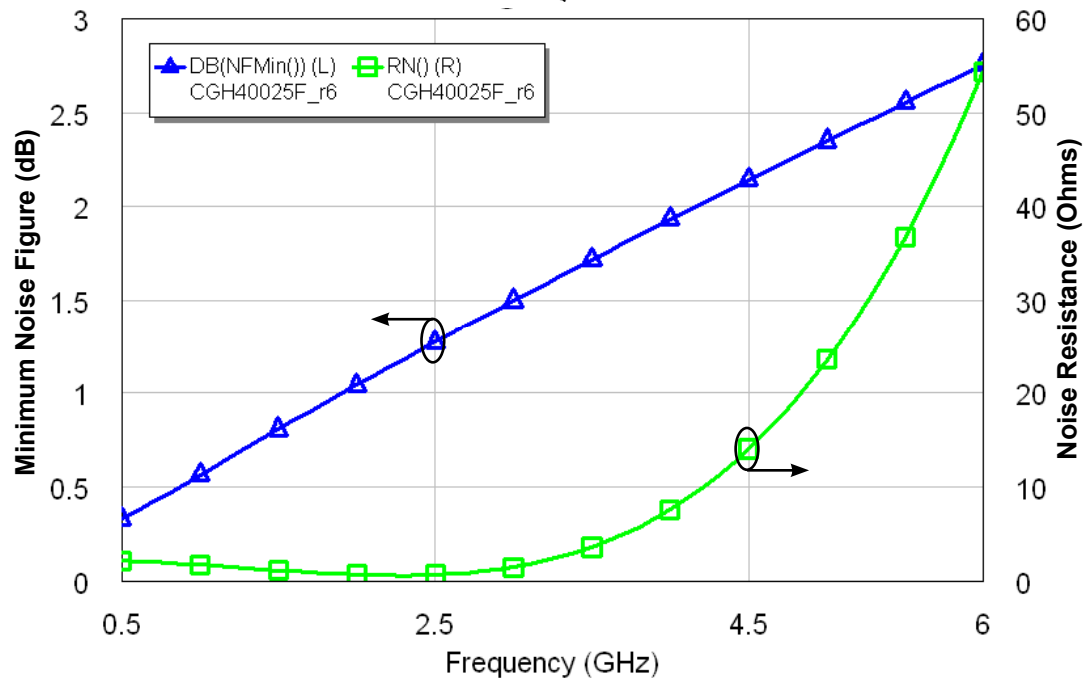


Maximum Available Gain and K Factor of the CGH40025
 $V_{DD} = 28\text{ V}$, $I_{DQ} = 250\text{ mA}$



Typical Noise Performance

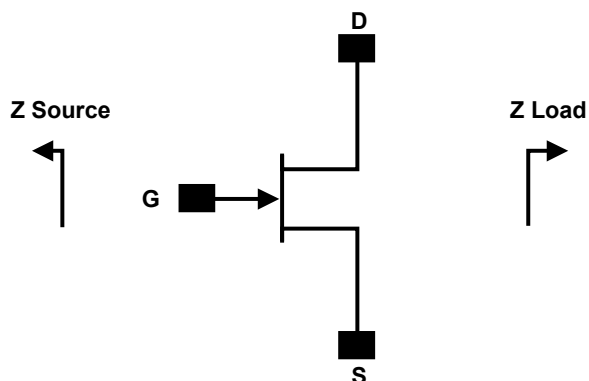
Simulated Minimum Noise Figure and Noise Resistance vs Frequency of the CGH40025F
 $V_{DD} = 28\text{ V}$, $I_{DQ} = 250\text{ mA}$



Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1A > 250 V	JEDEC JESD22 A114-D
Charge Device Model	CDM	1 < 200 V	JEDEC JESD22 C101-C

Source and Load Impedances



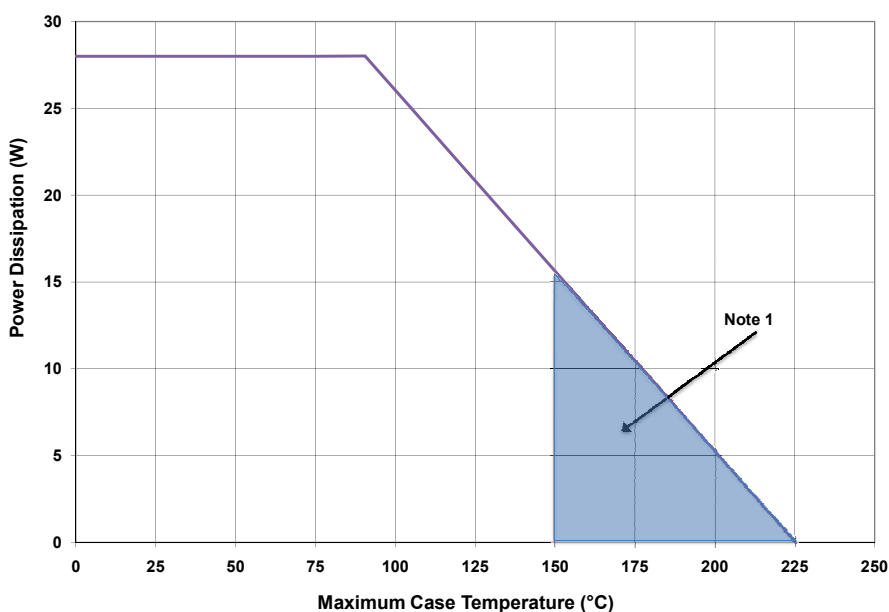
Frequency (MHz)	Z Source	Z Load
500	$7.75 + j15.5$	$20 + j5.2$
1000	$3.11 + j5.72$	$17 + j6.66$
1500	$2.86 + j1.63$	$16.8 + j3.2$
2500	$2.4 - j3.52$	$8.02 + j4.32$
3500	$1.31 - j7.3$	$5.85 - j0.51$

Note 1. $V_{DD} = 28V$, $I_{DQ} = 250mA$ in the 440166 package.

Note 2. Optimized for power gain, P_{SAT} and PAE.

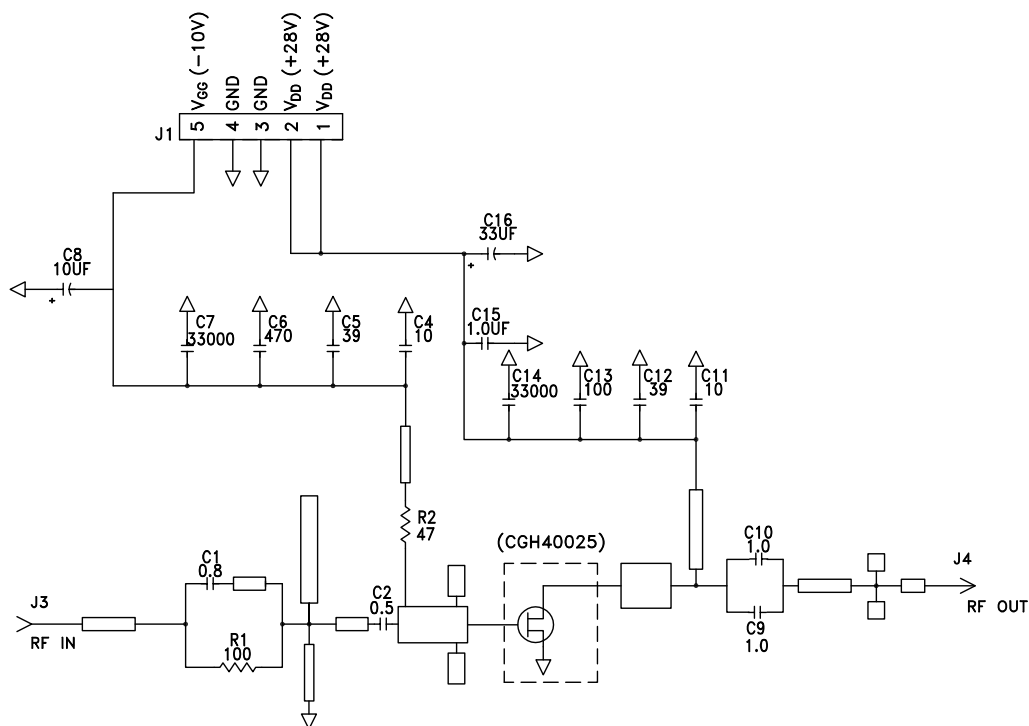
Note 3. When using this device at low frequency, series resistors should be used to maintain amplifier stability.

CGH40025 Power Dissipation De-rating Curve

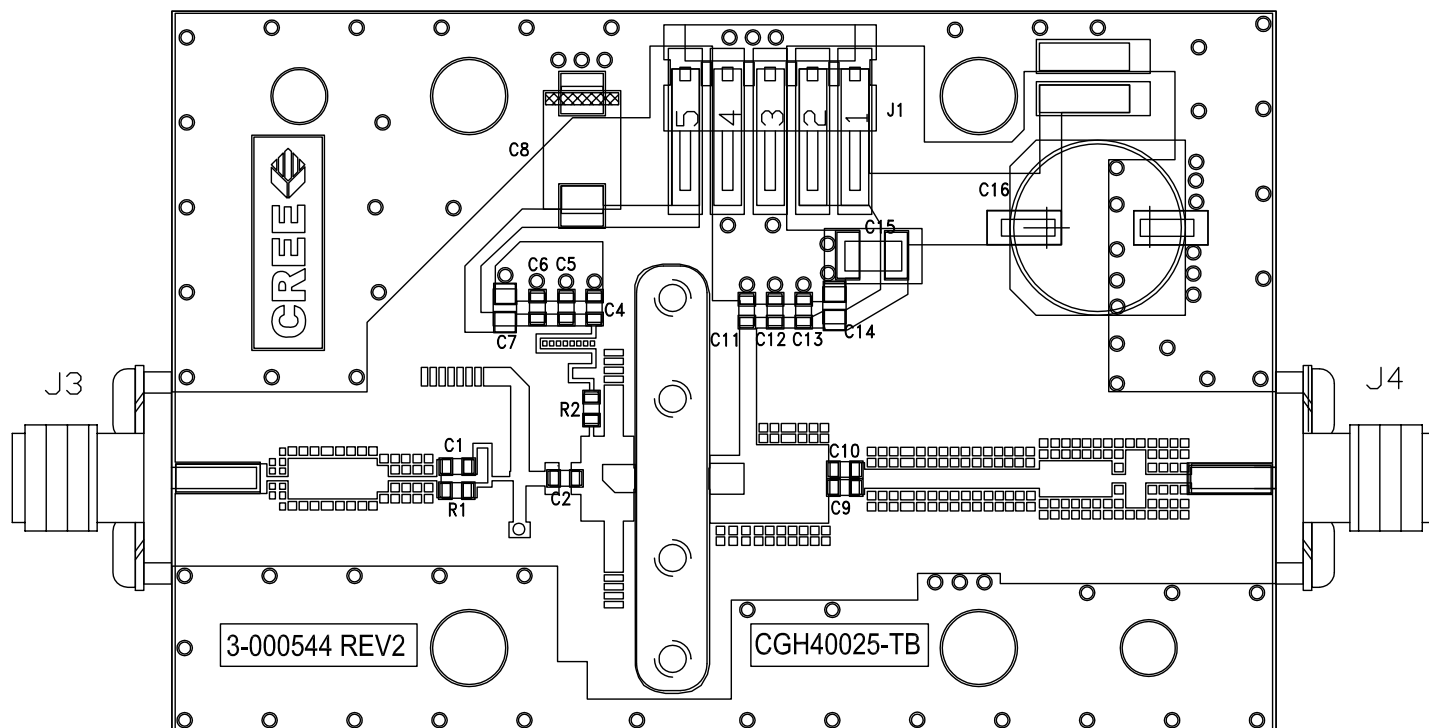


Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2).

CGH40025-AMP Demonstration Amplifier Circuit Schematic



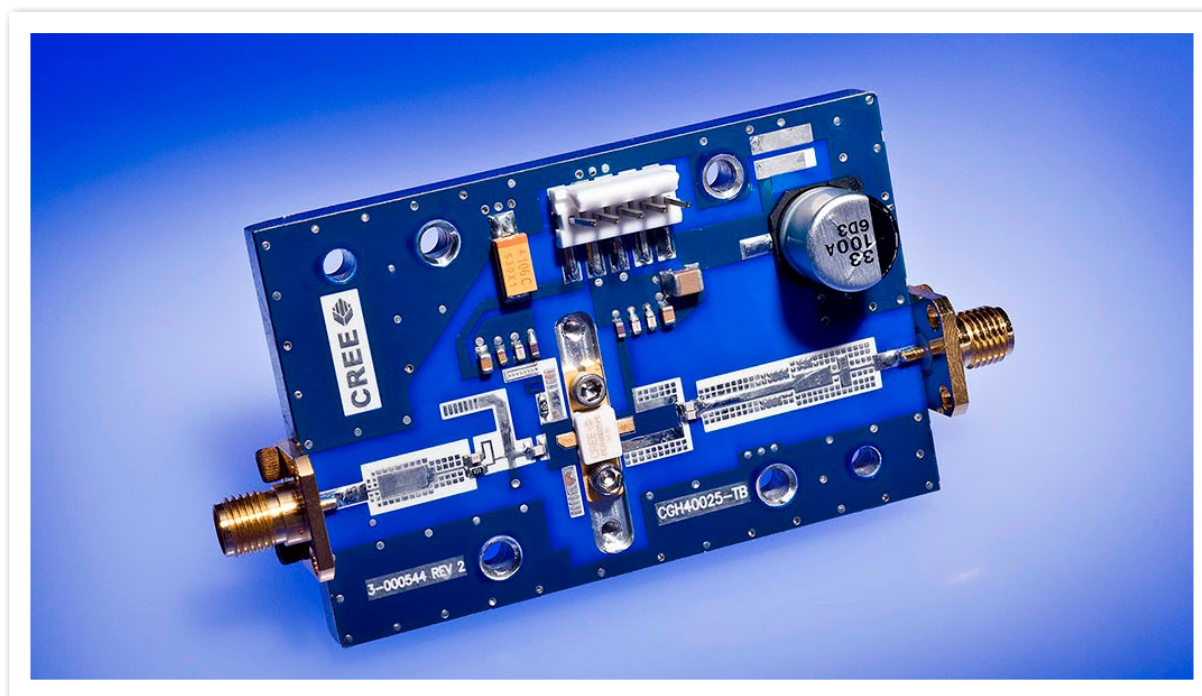
CGH40025-AMP Demonstration Amplifier Circuit Outline



CGH40025-AMP Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
R2	RES,1/16W,0603,1%,47 OHMS	1
R1	RES,1/16W,0603,1%,100 OHMS	1
C6	CAP, 470PF, 5%,100V, 0603	1
C16	CAP, 33 UF, 20%, G CASE	1
C15	CAP, 1.0UF, 100V, 10%, X7R, 1210	1
C8	CAP 10UF 16V TANTALUM	1
C13	CAP, 100.0pF, +/-5%, 0603	1
C1	CAP, 0.8pF, +/-0.1pF, 0603	1
C2	CAP, 0.5pF, +/-0.05pF, 0603	1
C9,C10	CAP, 1.0pF, +/-0.1pF, 0603	2
C4,C11	CAP, 10.0pF,+/-5%, 0603	2
C5,C12	CAP, 39pF, +/-5%, 0603	2
C7,C14	CAP,33000PF, 0805,100V, X7R	2
J3,J4	CONN SMA STR PANEL JACK RECP	2
J1	HEADER RT>PLZ .1CEN LK 5POS	1
-	PCB, RO4350B, Er = 3.48, h = 20 mil	1
-	CGH40025F or CGH40025P	1

CGH40025F-AMP Demonstration Amplifier Circuit



Typical Package S-Parameters for CGH40025 **(Small Signal, $V_{DS} = 28\text{ V}$, $I_{DQ} = 100\text{ mA}$, angle in degrees)**

Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.902	-151.72	11.80	92.09	0.025	6.22	0.393	-140.34
600 MHz	0.901	-157.13	9.89	87.31	0.025	2.28	0.402	-143.54
700 MHz	0.900	-161.20	8.49	83.18	0.025	-0.99	0.412	-145.64
800 MHz	0.900	-164.41	7.42	79.49	0.025	-3.82	0.424	-147.11
900 MHz	0.901	-167.04	6.58	76.10	0.024	-6.33	0.436	-148.22
1.0 GHz	0.902	-169.26	5.89	72.93	0.024	-8.60	0.449	-149.12
1.1 GHz	0.903	-171.19	5.33	69.93	0.024	-10.69	0.462	-149.91
1.2 GHz	0.904	-172.89	4.86	67.07	0.023	-12.61	0.476	-150.65
1.3 GHz	0.905	-174.43	4.45	64.33	0.023	-14.39	0.489	-151.38
1.4 GHz	0.906	-175.84	4.10	61.68	0.022	-16.06	0.503	-152.12
1.5 GHz	0.907	-177.14	3.80	59.12	0.022	-17.61	0.517	-152.87
1.6 GHz	0.909	-178.36	3.54	56.64	0.022	-19.05	0.531	-153.65
1.7 GHz	0.910	-179.52	3.30	54.22	0.021	-20.38	0.545	-154.46
1.8 GHz	0.912	-179.38	3.09	51.87	0.021	-21.62	0.558	-155.29
1.9 GHz	0.913	-178.33	2.90	49.58	0.020	-22.75	0.571	-156.15
2.0 GHz	0.914	-177.30	2.73	47.34	0.020	-23.78	0.584	-157.04
2.1 GHz	0.916	-176.31	2.58	45.15	0.019	-24.70	0.596	-157.95
2.2 GHz	0.917	-175.34	2.44	43.02	0.019	-25.52	0.608	-158.88
2.3 GHz	0.918	-174.39	2.31	40.92	0.018	-26.22	0.620	-159.82
2.4 GHz	0.920	-173.46	2.19	38.88	0.018	-26.82	0.631	-160.78
2.5 GHz	0.921	-172.54	2.09	36.87	0.017	-27.29	0.642	-161.76
2.6 GHz	0.922	-171.63	1.99	34.91	0.016	-27.64	0.652	-162.74
2.7 GHz	0.923	-170.73	1.90	32.98	0.016	-27.85	0.662	-163.73
2.8 GHz	0.925	-169.84	1.82	31.09	0.015	-27.92	0.672	-164.73
2.9 GHz	0.926	-168.95	1.74	29.24	0.015	-27.85	0.681	-165.73
3.0 GHz	0.927	-168.07	1.67	27.41	0.014	-27.61	0.690	-166.74
3.2 GHz	0.929	-166.30	1.54	23.86	0.013	-26.63	0.706	-168.76
3.4 GHz	0.931	-164.54	1.42	20.42	0.013	-24.89	0.721	-170.79
3.6 GHz	0.932	-162.78	1.33	17.08	0.012	-22.30	0.735	-172.82
3.8 GHz	0.934	-161.00	1.24	13.84	0.011	-18.80	0.748	-174.85
4.0 GHz	0.935	-159.21	1.16	10.67	0.011	-14.40	0.759	-176.88
4.2 GHz	0.936	-157.39	1.10	7.58	0.010	-9.18	0.769	-178.90
4.4 GHz	0.937	-155.55	1.04	4.55	0.010	-3.38	0.778	-179.07
4.6 GHz	0.938	-153.67	0.98	1.57	0.010	2.65	0.787	-177.04
4.8 GHz	0.939	-151.77	0.94	-1.36	0.011	8.52	0.794	-175.00
5.0 GHz	0.939	-149.82	0.89	-4.25	0.011	13.87	0.801	-172.96
5.2 GHz	0.939	-147.82	0.86	-7.11	0.012	18.48	0.807	-170.90
5.4 GHz	0.939	-145.78	0.82	-9.95	0.013	22.25	0.812	-168.83
5.6 GHz	0.940	-143.68	0.79	-12.78	0.014	25.17	0.817	-166.74
5.8 GHz	0.939	-141.53	0.77	-15.59	0.016	27.32	0.821	-164.62
6.0 GHz	0.939	-139.31	0.74	-18.41	0.017	28.77	0.825	-162.48

To download the s-parameters in s2p format, go to the [CGH40025 Product Page](#) and click on the documentation tab.

Typical Package S-Parameters for CGH40025

(Small Signal, $V_{DS} = 28\text{ V}$, $I_{DQ} = 250\text{ mA}$, angle in degrees)

Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.917	-157.22	12.62	91.45	0.018	7.56	0.458	-158.97
600 MHz	0.916	-161.92	10.57	87.33	0.018	4.70	0.465	-160.93
700 MHz	0.916	-165.46	9.07	83.78	0.018	2.41	0.472	-162.19
800 MHz	0.916	-168.28	7.94	80.58	0.018	0.51	0.478	-163.04
900 MHz	0.916	-170.61	7.05	77.64	0.017	-1.12	0.485	-163.64
1.0 GHz	0.916	-172.60	6.33	74.88	0.017	-2.55	0.493	-164.09
1.1 GHz	0.917	-174.33	5.74	72.25	0.017	-3.82	0.500	-164.45
1.2 GHz	0.917	-175.88	5.24	69.73	0.017	-4.94	0.508	-164.77
1.3 GHz	0.918	-177.28	4.82	67.30	0.017	-5.95	0.516	-165.06
1.4 GHz	0.918	-178.57	4.46	64.94	0.017	-6.84	0.525	-165.36
1.5 GHz	0.919	-179.78	4.14	62.65	0.016	-7.63	0.533	-165.67
1.6 GHz	0.919	179.09	3.87	60.41	0.016	-8.31	0.542	-165.99
1.7 GHz	0.920	178.01	3.62	58.22	0.016	-8.90	0.550	-166.35
1.8 GHz	0.921	176.98	3.40	56.07	0.016	-9.39	0.559	-166.73
1.9 GHz	0.921	175.99	3.21	53.97	0.015	-9.77	0.568	-167.14
2.0 GHz	0.922	175.03	3.03	51.90	0.015	-10.06	0.577	-167.59
2.1 GHz	0.923	174.09	2.87	49.87	0.015	-10.24	0.585	-168.07
2.2 GHz	0.924	173.17	2.73	47.87	0.014	-10.31	0.594	-168.57
2.3 GHz	0.924	172.27	2.60	45.91	0.014	-10.27	0.602	-169.11
2.4 GHz	0.925	171.39	2.47	43.97	0.014	-10.12	0.610	-169.67
2.5 GHz	0.926	170.51	2.36	42.07	0.014	-9.85	0.619	-170.26
2.6 GHz	0.926	169.65	2.26	40.19	0.013	-9.46	0.626	-170.88
2.7 GHz	0.927	168.79	2.16	38.34	0.013	-8.95	0.634	-171.52
2.8 GHz	0.928	167.93	2.08	36.52	0.013	-8.31	0.642	-172.17
2.9 GHz	0.928	167.08	1.99	34.72	0.013	-7.54	0.649	-172.85
3.0 GHz	0.929	166.24	1.92	32.94	0.013	-6.65	0.656	-173.55
3.2 GHz	0.930	164.54	1.78	29.45	0.012	-4.49	0.670	-175.00
3.4 GHz	0.931	162.85	1.66	26.05	0.012	-1.85	0.683	-176.50
3.6 GHz	0.932	161.14	1.55	22.72	0.012	1.19	0.695	-178.06
3.8 GHz	0.933	159.42	1.46	19.46	0.012	4.55	0.706	-179.66
4.0 GHz	0.933	157.68	1.38	16.27	0.012	8.08	0.716	178.70
4.2 GHz	0.934	155.91	1.31	13.12	0.012	11.64	0.726	177.02
4.4 GHz	0.934	154.11	1.24	10.03	0.013	15.08	0.735	175.30
4.6 GHz	0.935	152.28	1.18	6.97	0.013	18.26	0.743	173.56
4.8 GHz	0.935	150.41	1.13	3.95	0.014	21.09	0.750	171.78
5.0 GHz	0.935	148.49	1.08	0.96	0.015	23.50	0.756	169.97
5.2 GHz	0.935	146.53	1.04	-2.00	0.016	25.48	0.762	168.12
5.4 GHz	0.935	144.52	1.00	-4.96	0.017	27.02	0.768	166.24
5.6 GHz	0.935	142.45	0.97	-7.90	0.018	28.12	0.773	164.32
5.8 GHz	0.934	140.31	0.94	-10.84	0.020	28.83	0.777	162.36
6.0 GHz	0.934	138.12	0.91	-13.79	0.021	29.18	0.781	160.36

To download the s-parameters in s2p format, go to the [CGH40025 Product Page](#) and click on the documentation tab.

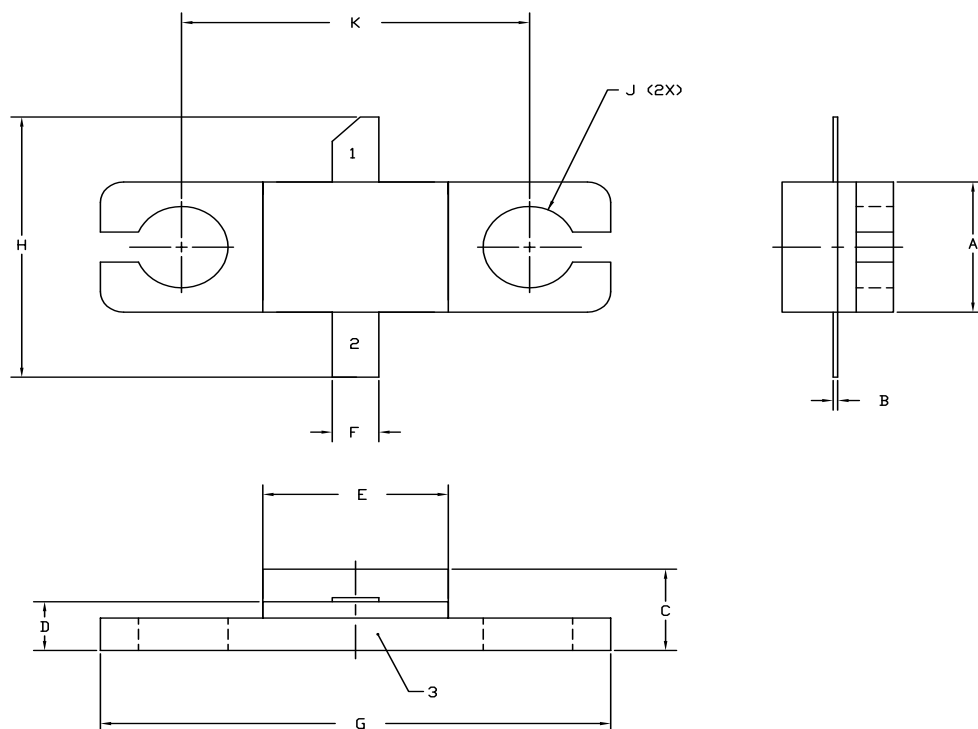
Typical Package S-Parameters for CGH40025

(Small Signal, $V_{DS} = 28\text{ V}$, $I_{DQ} = 400\text{ mA}$, angle in degrees)

Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.924	-159.12	12.64	91.13	0.015	8.27	0.485	-163.72
600 MHz	0.923	-163.56	10.58	87.23	0.015	5.84	0.491	-165.34
700 MHz	0.923	-166.92	9.08	83.86	0.015	3.96	0.497	-166.41
800 MHz	0.923	-169.60	7.95	80.83	0.015	2.43	0.502	-167.13
900 MHz	0.923	-171.82	7.06	78.03	0.015	1.16	0.508	-167.65
1.0 GHz	0.923	-173.72	6.34	75.40	0.015	0.08	0.514	-168.05
1.1 GHz	0.923	-175.39	5.75	72.89	0.015	-0.84	0.520	-168.36
1.2 GHz	0.924	-176.88	5.26	70.48	0.015	-1.62	0.526	-168.63
1.3 GHz	0.924	-178.24	4.84	68.15	0.015	-2.29	0.533	-168.88
1.4 GHz	0.924	-179.50	4.48	65.89	0.015	-2.85	0.539	-169.13
1.5 GHz	0.925	-179.33	4.17	63.68	0.014	-3.31	0.546	-169.38
1.6 GHz	0.925	-178.22	3.89	61.52	0.014	-3.67	0.553	-169.65
1.7 GHz	0.926	-177.17	3.65	59.41	0.014	-3.93	0.560	-169.94
1.8 GHz	0.926	-176.16	3.43	57.34	0.014	-4.09	0.568	-170.26
1.9 GHz	0.927	-175.18	3.24	55.30	0.014	-4.16	0.575	-170.60
2.0 GHz	0.927	-174.24	3.07	53.29	0.014	-4.13	0.582	-170.97
2.1 GHz	0.928	-173.32	2.91	51.32	0.013	-4.00	0.589	-171.36
2.2 GHz	0.928	-172.41	2.76	49.38	0.013	-3.76	0.597	-171.79
2.3 GHz	0.929	-171.53	2.63	47.46	0.013	-3.43	0.604	-172.24
2.4 GHz	0.929	-170.65	2.51	45.57	0.013	-2.99	0.611	-172.71
2.5 GHz	0.929	-169.79	2.40	43.71	0.013	-2.44	0.618	-173.22
2.6 GHz	0.930	-168.93	2.30	41.87	0.013	-1.79	0.625	-173.75
2.7 GHz	0.930	-168.08	2.20	40.05	0.012	-1.04	0.632	-174.30
2.8 GHz	0.931	-167.24	2.12	38.26	0.012	-0.18	0.638	-174.87
2.9 GHz	0.931	-166.40	2.04	36.48	0.012	0.77	0.645	-175.47
3.0 GHz	0.932	-165.56	1.96	34.73	0.012	1.82	0.651	-176.08
3.2 GHz	0.932	-163.88	1.82	31.28	0.012	4.18	0.663	-177.37
3.4 GHz	0.933	-162.20	1.70	27.91	0.012	6.83	0.675	-178.72
3.6 GHz	0.934	-160.51	1.60	24.60	0.012	9.69	0.686	-179.86
3.8 GHz	0.934	-158.80	1.51	21.35	0.012	12.64	0.696	-178.39
4.0 GHz	0.935	-157.07	1.42	18.16	0.013	15.58	0.706	-176.88
4.2 GHz	0.935	-155.32	1.35	15.01	0.013	18.40	0.715	-175.31
4.4 GHz	0.935	-153.53	1.29	11.91	0.014	21.01	0.723	-173.70
4.6 GHz	0.935	-151.70	1.23	8.84	0.014	23.33	0.730	-172.05
4.8 GHz	0.935	-149.84	1.17	5.80	0.015	25.32	0.737	-170.36
5.0 GHz	0.935	-147.93	1.13	2.79	0.016	26.96	0.743	-168.63
5.2 GHz	0.935	-145.98	1.09	-0.20	0.017	28.24	0.749	-166.86
5.4 GHz	0.935	-143.97	1.05	-3.19	0.018	29.16	0.754	-165.05
5.6 GHz	0.934	-141.91	1.01	-6.16	0.020	29.75	0.759	-163.20
5.8 GHz	0.934	-139.78	0.98	-9.14	0.021	30.02	0.763	-161.30
6.0 GHz	0.933	-137.58	0.96	-12.12	0.023	29.99	0.767	-159.35

To download the s-parameters in s2p format, go to the [CGH40025 Product Page](#) and click on the documentation tab.

Product Dimensions CGH40025F (Package Type – 440166)



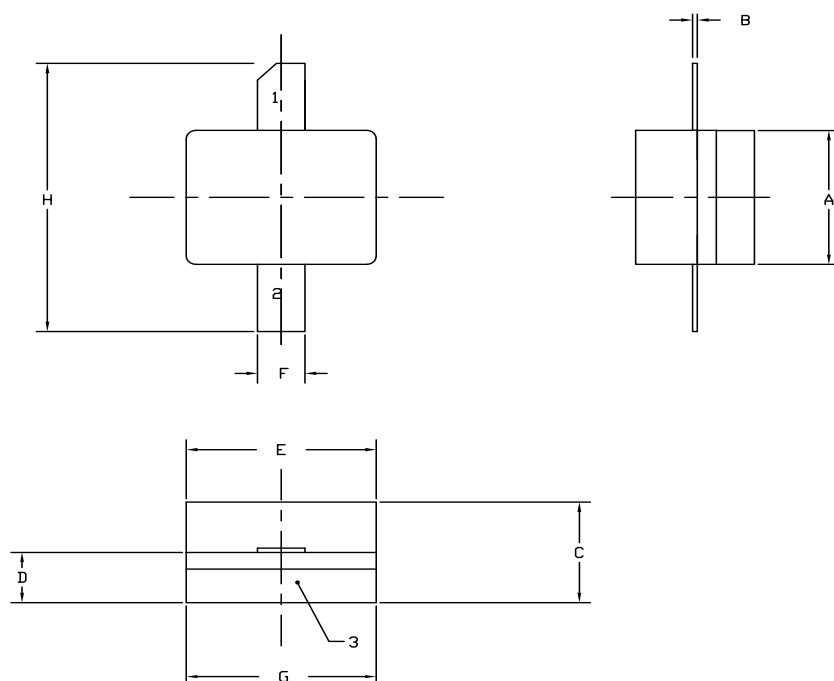
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.155	0.165	3.94	4.19
B	0.004	0.006	0.10	0.15
C	0.115	0.135	2.92	3.43
D	0.057	0.067	1.45	1.70
E	0.195	0.205	4.95	5.21
F	0.045	0.055	1.14	1.40
G	0.545	0.555	13.84	14.09
H	0.280	0.360	7.11	9.14
J	ϕ .100		2.54	
K	0.375		9.53	

PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE

Product Dimensions CGH40025P (Package Type – 440196)



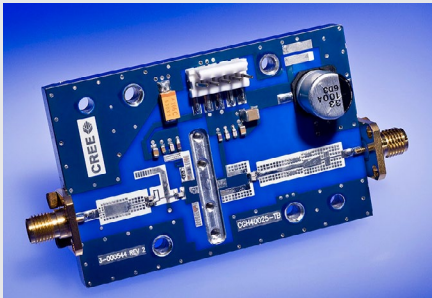
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.155	0.165	3.94	4.19
B	0.003	0.006	0.10	0.15
C	0.115	0.135	2.92	3.17
D	0.057	0.067	1.45	1.70
E	0.195	0.205	4.95	5.21
F	0.045	0.055	1.14	1.40
G	0.195	0.205	4.95	5.21
H	0.280	0.360	7.11	9.14

PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE

Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGH40025F	GaN HEMT	Each	
CGH40025P	GaN HEMT	Each	
CGH40025F-TB	Test board without GaN HEMT	Each	
CGH40025F-AMP	Test board with GaN HEMT installed	Each	

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For more information, please contact:

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
www.cree.com/RF

Sarah Miller
Marketing & Export
Cree, RF Components
1.919.407.5302

Ryan Baker
Marketing
Cree, RF Components
1.919.407.7816

Tom Dekker
Sales Director
Cree, RF Components
1.919.407.5639